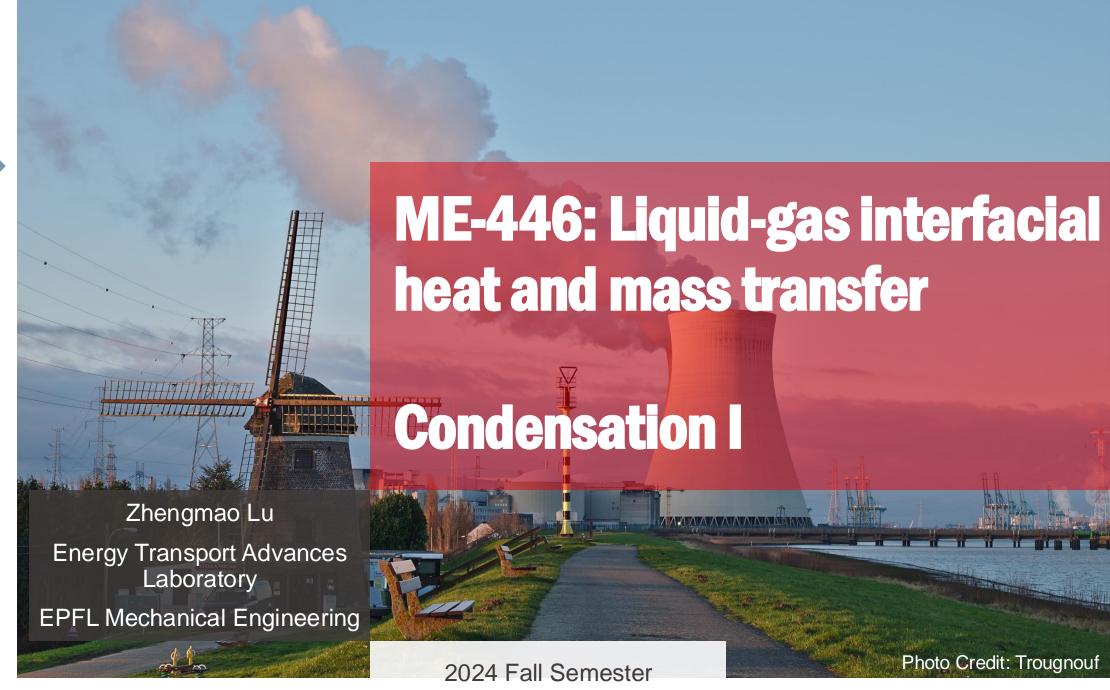
EPFL

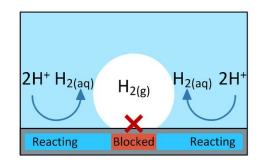




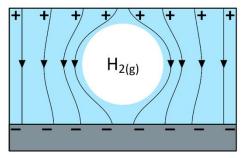
Last Time



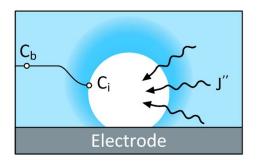
Bubbles and electrochemical reactions



Blocking reaction area



Additional resistance for ion transport

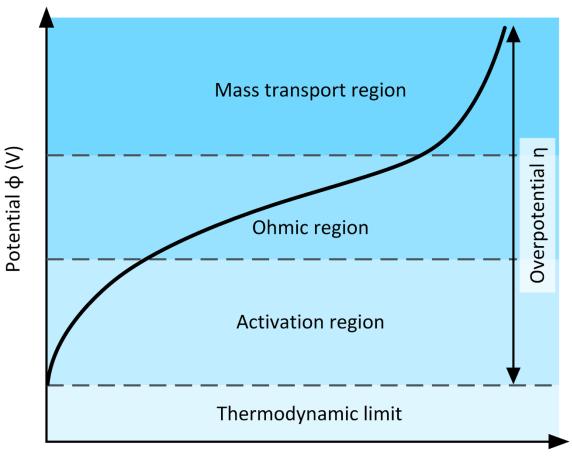


Additional diffusion resistance Bubble-induced convection



Impact on Electrochemical Overpotentials





Current density i (A/cm²)

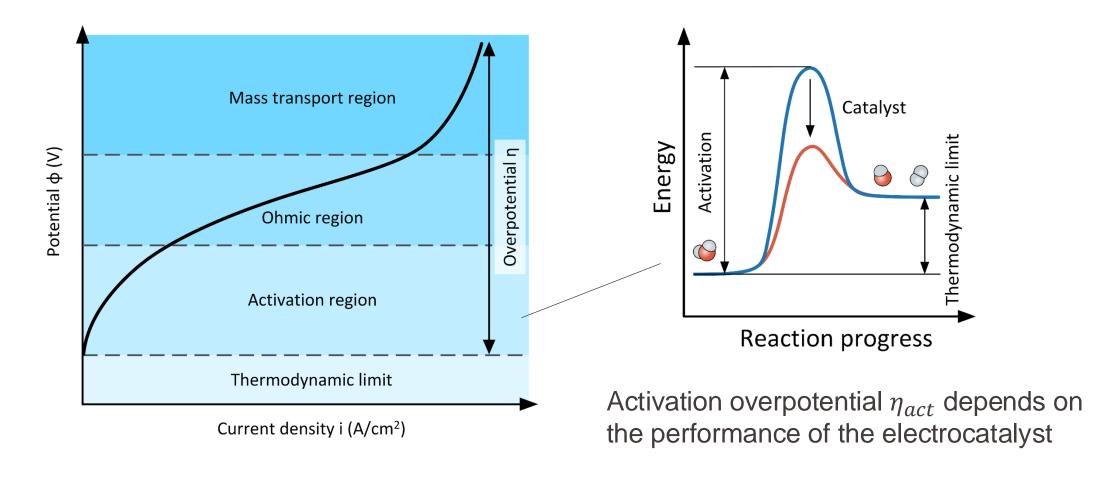
Overpotential (η) is the additional voltage required to drive the electrochemical process over the thermodynamic limit $\phi_{\rm th}$

Energy efficiency of an electrolytic cell



Activation Overpotentials

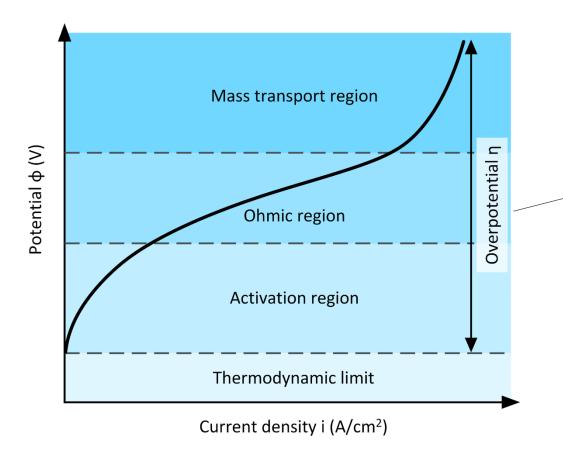


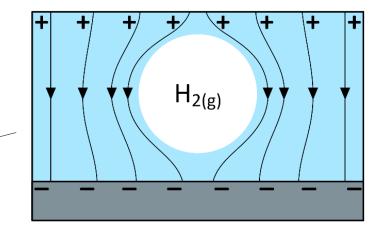




Ohmic Overpotentials





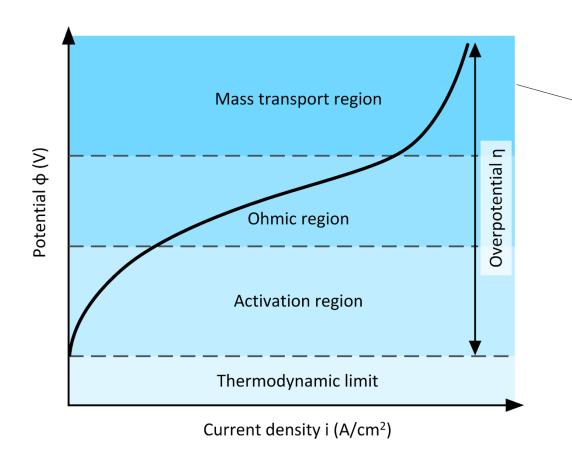


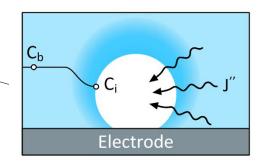
Gas bubbles are electrically insulating, which creates additional resistance for ion transport across the electrolyte



Concentration Overpotentials





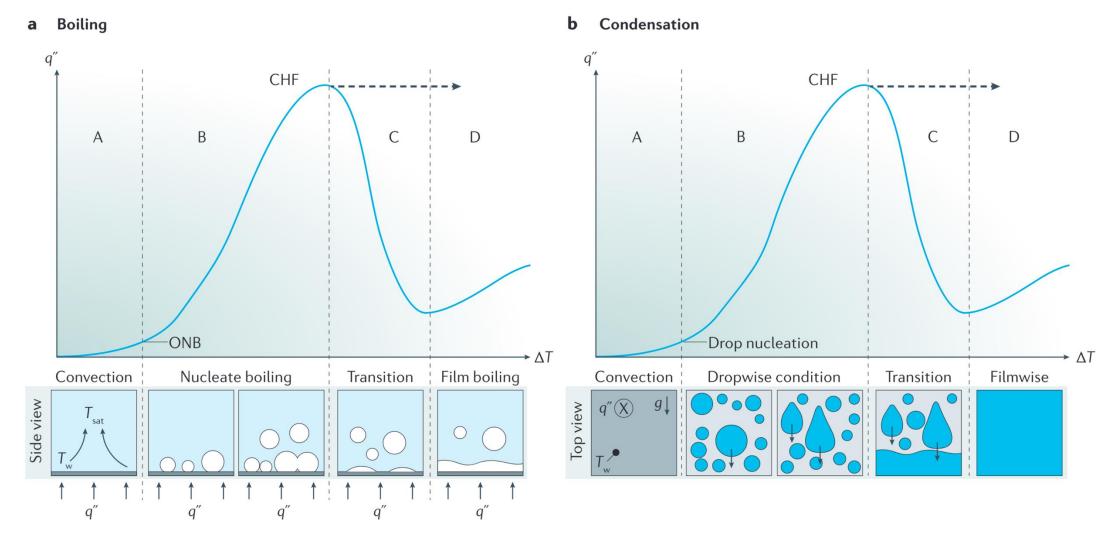


At higher current densities, the reaction may be limited by how quickly the reactants and products are transferred to and away from the electrode (not driven by electrical field)



Boiling vs Condensation





19.11.2024

DOI: 10.1038/natrevmats.2016.92



Why Condensation Matters







Ashalim Solar Power Station

Condenser, Holtec



Why Condensation Matters







EPFL Data Center

Condensers, STACK



Intended Learning Objectives



- Nucleation in condensation
- Rose's analysis of dropwise condensation
- Nusselt's analysis of filmwise condensation

Carey, Chapter 9



Droplet Embryo



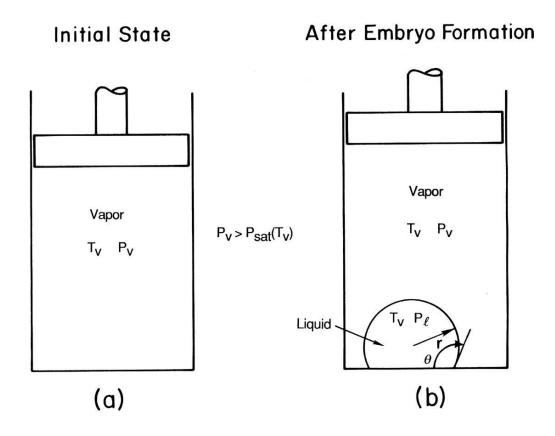


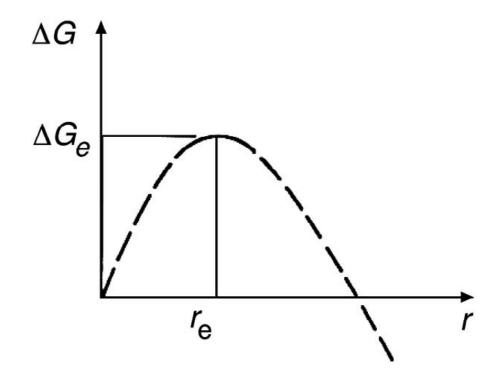
Figure 9.2 in Carey



Droplet Embryo



• Tailor expansion of ΔG near r_e



Density fluctuation in supercooled vapor produces droplets of random r

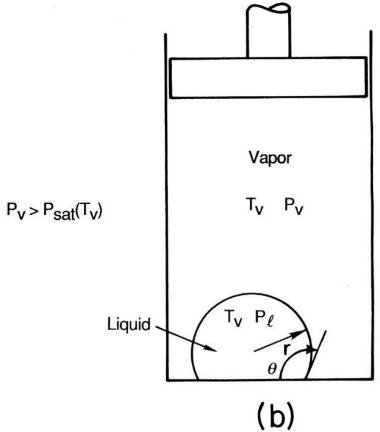
If $r < r_e$, the droplet collapses If $r > r_e$, the droplet grows



Equilibrium Droplet Radius



After Embryo Formation

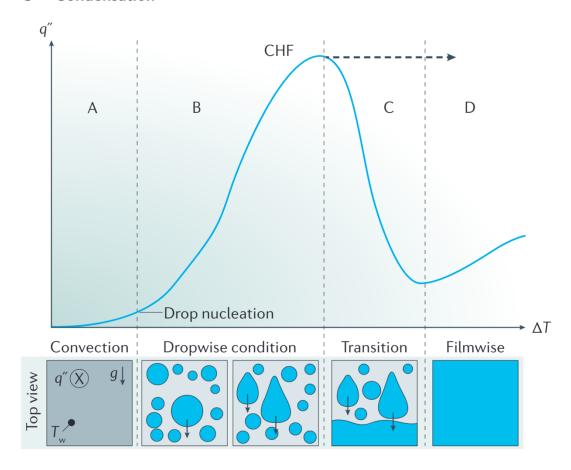




Dropwise Condensation



b Condensation



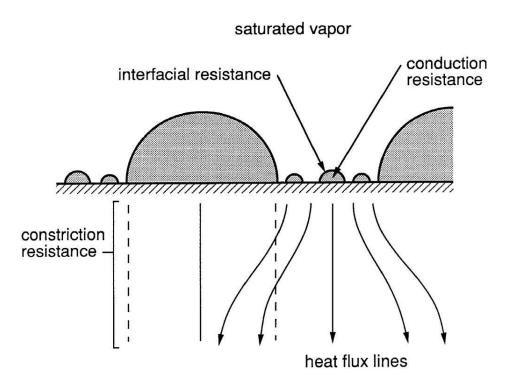


https://doi.org/10.1021/nl303835d



Thermal Resistance Associated with a Droplet





- Interfacial resistance
- Curvature induced resistance
- Conduction through droplet
- Constriction resistance



Interfacial Resistance

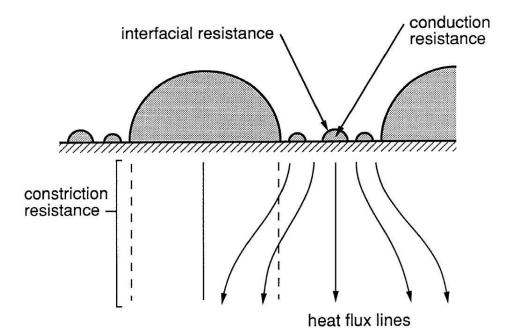




Interfacial Resistance



saturated vapor





Curvature-Induced Resistance



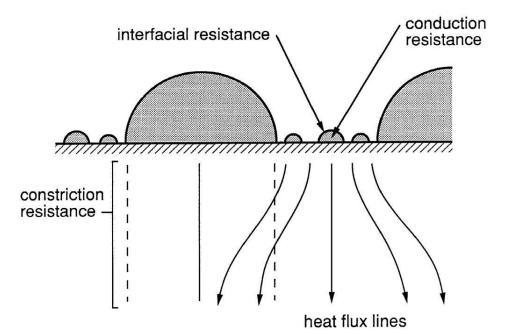
Given a droplet radius *r*, the equilibrium droplet temperature at the interface should follow



Conduction Resistance



saturated vapor

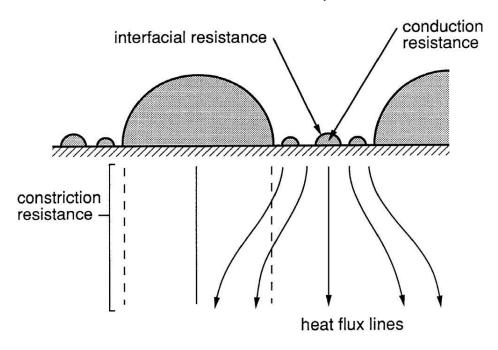




Overall Droplet Resistance







- Interfacial resistance
- Curvature induced resistance
- Conduction through droplet
- Constriction resistance



Distribution of Droplet Radii



Cumulative distribution function (postulated form)

Probability distribution function



Dropwise Condensation Heat Transfer



For For dropwise condensation of steam at pressures below 1 atm, Rose et al. recommended the following empirical correlation for the heat transfer coefficient

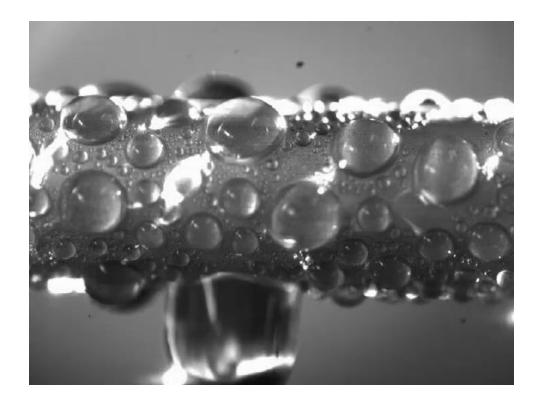
$$h_{dc} = T_v^{0.8} [5 + 0.3(T_{sat} - T_w)]$$
 Eq. 9.42 in Carey

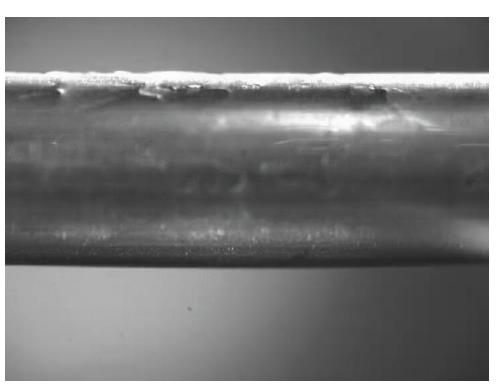
Temperature in Celsius and HTC in kW/m²K



Dropwise vs Filmwise Condensation







Dropwise condensation

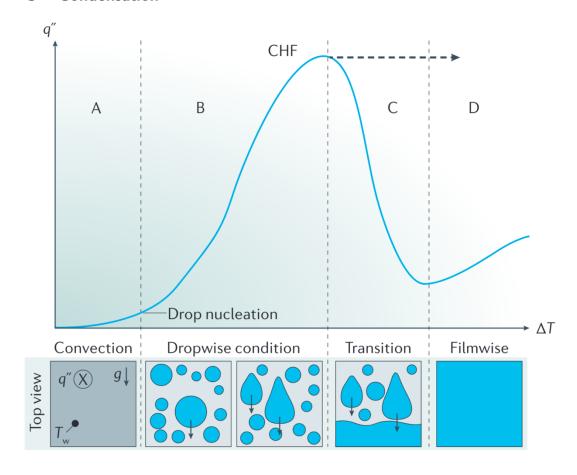
Filmwise condensation



Dropwise vs Filmwise Condensation



b Condensation



Data obtained by Takeyama and Shimizu [9.40] for condensation of steam on a short vertical copper surface.

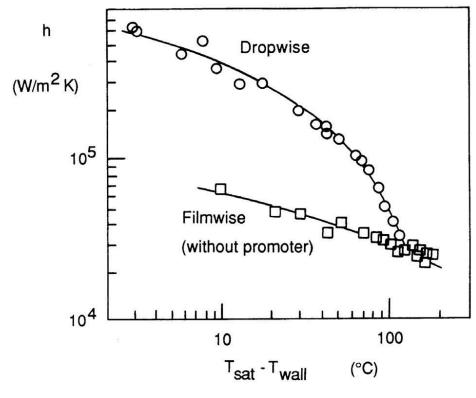
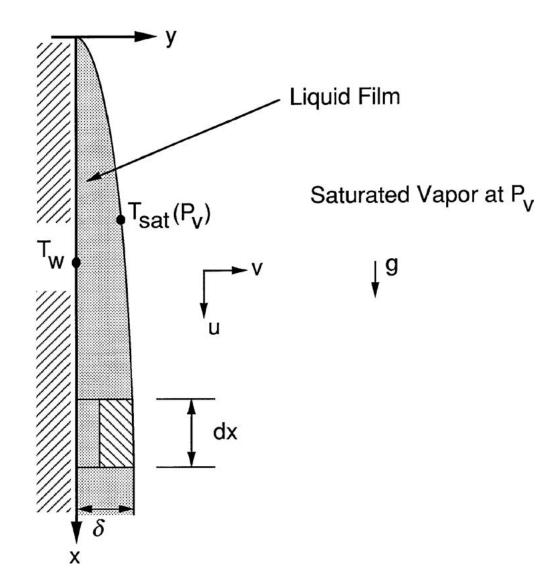


Figure 9.6 in Carey



Filmwise Condensation on a Flat Vertical Surface

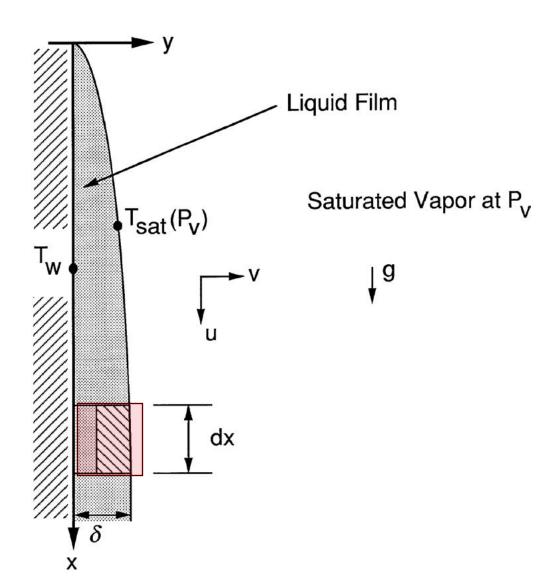






Energy Balance

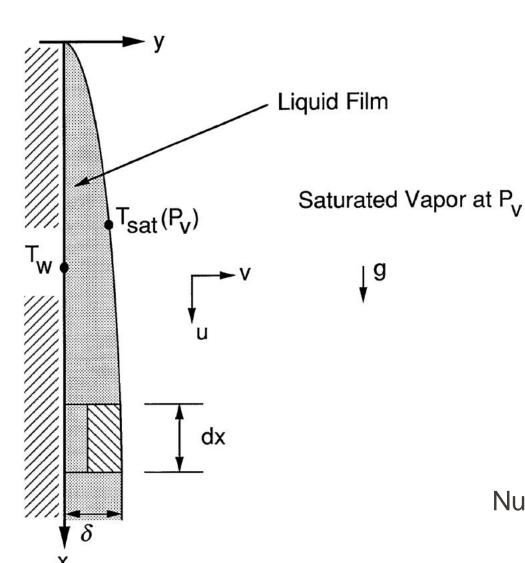






Filmwise Condensation HTC





Nusselt equation for filmwise condensation



Additional Comments



- Filmwise condensation still the most common operation mode in industry
 - · Not as bad as film boiling as liquid is much more conductive than vapor
- Dropwise condensation requires strong hydrophobicity at high supersaturation (droplets must roll off the surface quickly before flooding occurs). However, maintaining strong hydrophobicity over extended period is challenging.